### 506529243 03/01/2021

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
LI WANG	02/03/2021
DENGZHENG GAO	02/03/2021
LIHUA LIU	02/03/2021
QINGBIN GUO	02/03/2021
ZHEN XUE	02/03/2021

#### **RECEIVING PARTY DATA**

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City:	QINGDAO, SHANDONG
State/Country:	CHINA
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#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17188087

#### **CORRESPONDENCE DATA**

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SIGNATURE:	/Andrew D Bochner/
DATE SIGNED:	03/01/2021

PATENT 506529243 REEL: 055442 FRAME: 0717

# Total Attachments: 2 source=Assignment#page1.tif source=Assignment#page2.tif

PATENT REEL: 055442 FRAME: 0718

# ASSIGNMENT

For valuable consideration, we, WANG, Li, GAO, Dengzheng, LIU, Lihua, GUO, Qingbin and XUE, Zhen, hereby assign to:

## SHANDONG UNIVERSITY OF SCIENCE AND TECHNOLOGY

with offices at No. 579 QianWangang Road, Qingdao Economic and Technological Development Zone, Qingdao, Shandong 266590, China and its successors, assigns and legal representatives, all hereinafter referred to as the ASSIGNEE: (1) our entire right, title and interest for the United States and in all countries, in and to any and all inventions, discoveries and applications which are disclosed in United States Patent application entitled:

# METHOD FOR PRODUCING DUST-REDUCING AND DUST-ABSORBING MATERIAL FROM NONMETALLIC MINERAL AND RAW MATERIAL FROM CEMENT PLANT

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This assignment includes the foregoing patent application or patent, all legal equivalents in any country, continuation applications, divisional application, continuation-in-part applications, reissue applications, and all patents issuing from such legal equivalents; all patents, utility models, and design registrations granted by any jurisdiction for any of said inventions and improvements; and the right to claim priority based on the filing date of the foregoing patent application or patent under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes. We authorize the Assignee to apply in all countries in our names or in its own name for patents, utility models, and design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements.

We hereby state and agree that no assignment, sale, agreement, or encumbrance has been or will be made or entered into that would conflict with this assignment.

We further agree for ourselves and our respective heirs, legal representatives, and assigns to provide to the Assignee promptly upon its request and at its expense all pertinent facts and documents relating to any of said inventions and improvements or said patents and legal equivalents as may be known and accessible to us and to testify as to the same in any interference, litigation, or proceeding relating thereto; and we agree promptly to perform such lawful acts and to sign such further applications, assignments, statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Inventor's Signature:	
WANG, Li	<u> [ebruary 3.202]</u>
WANG, Li	Date
GAO, Deny zheng	<u>February 3.2021</u>
GAO, Dengzheng	Date
LIU, Lihua	<u>February 3.202</u>
LIU, Lihua	Date
<u>GUO, Qingbin</u> GUO, Qingbin	<u>Spruary 3. 2024</u> Date
GUO, Qingbin	Date
XUE Zhen	<u></u>
XUE, Zhen	Date